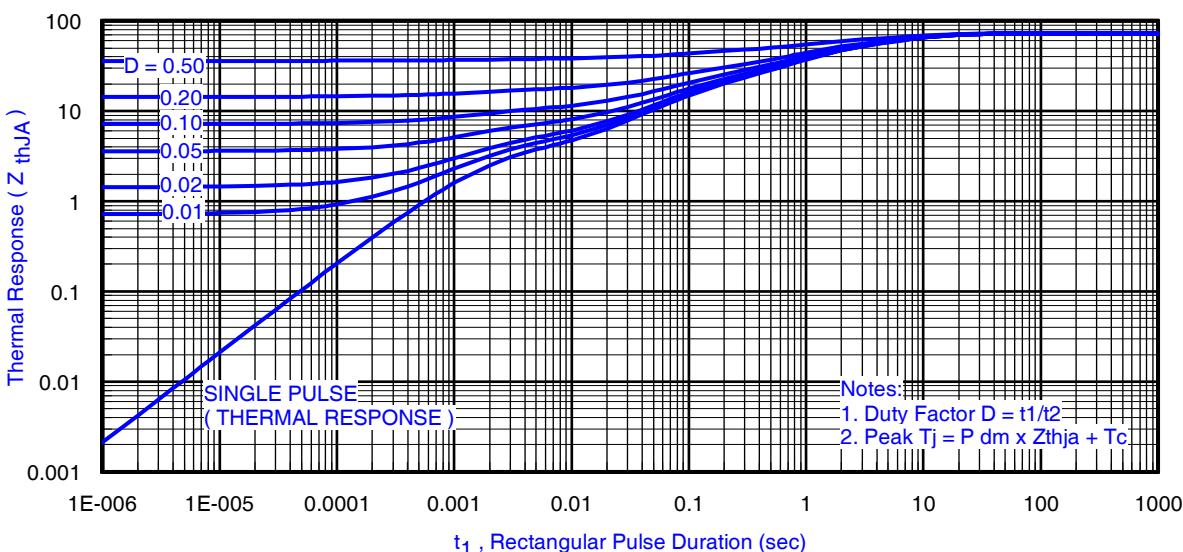


Absolute Maximum Ratings

	Parameter	Max.	Units
P _D @ T _A = 25°C	Power Dissipation ③	1.7	W
P _D @ T _A = 70°C	Power Dissipation ③	1.1	
P _D @ T _C = 25°C	Power Dissipation ④	25	
T _P	Peak Soldering Temperature	270	°C
T _J	Operating Junction and Storage Temperature Range	-40 to + 150	

Thermal Resistance

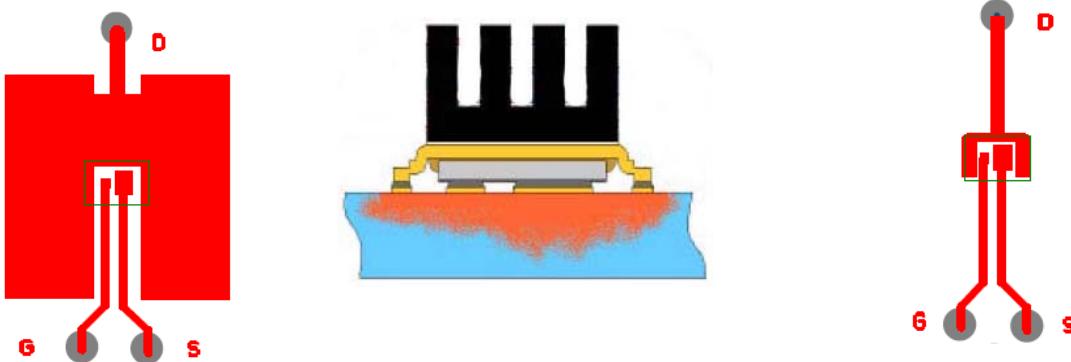
	Parameter	Typ.	Max.	Units
R _{0JA}	Junction-to-Ambient ⑤	—	72	°C/W
R _{0JA}	Junction-to-Ambient ⑥	12.5	—	
R _{0JA}	Junction-to-Ambient ⑦	20	—	
R _{0JC}	Junction-to-Case ④, ⑨	—	5.1	
R _{0J-PCB}	Junction-to-PCB Mounted	1.0	—	
	Linear Derating Factor ⑧	0.014	—	W/°C

**Fig 3.** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient ①**Notes:**

② Used double sided cooling, mounting pad with large heatsink.

⑨ R_0 is measured at T_J of approximately 90°C.

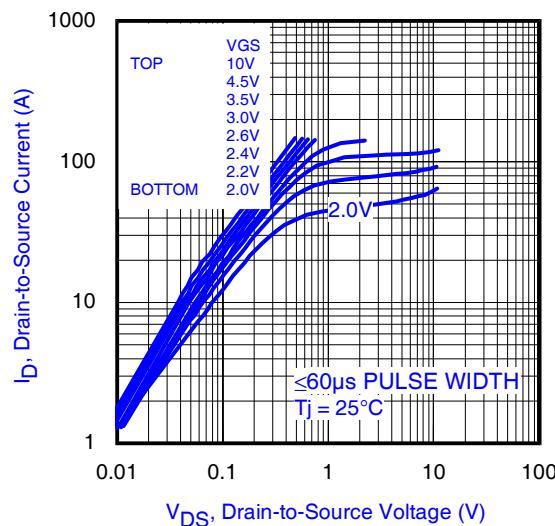
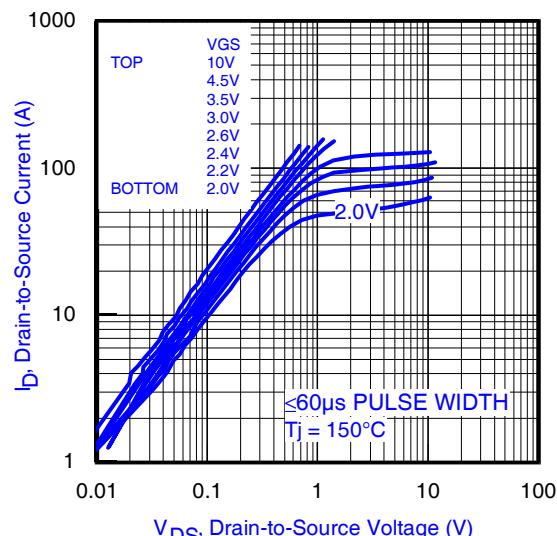
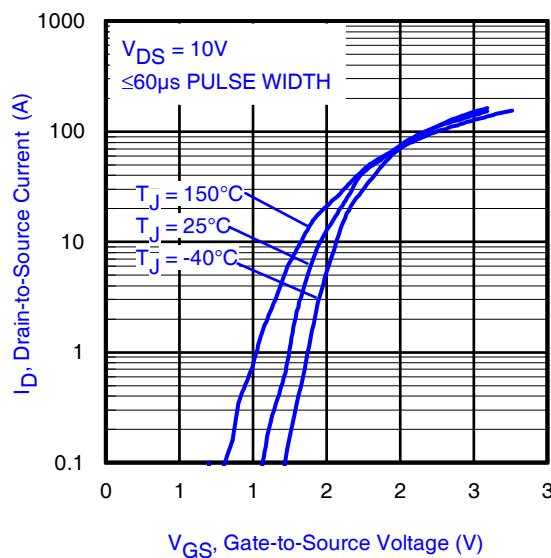
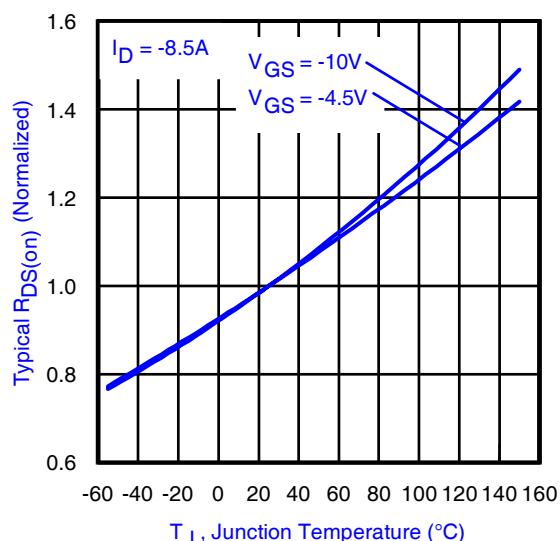
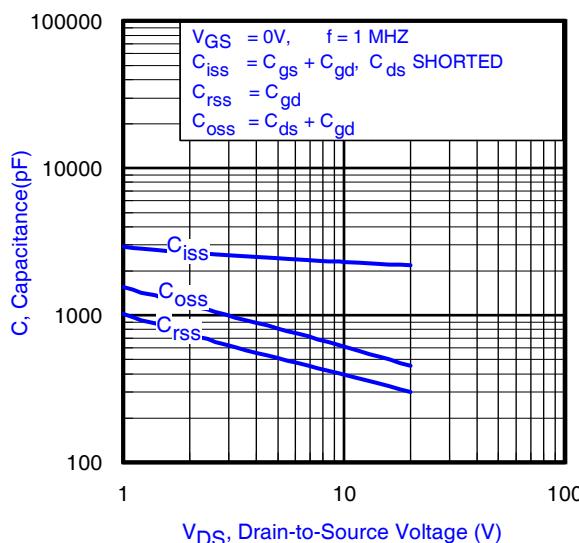
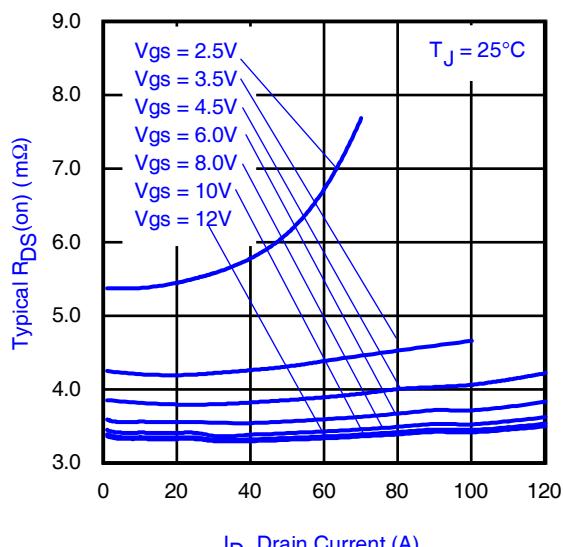
③ Mounted on minimum footprint full size board with metalized back and with small clip heatsink.



③ Surface mounted on 1 in. square Cu board (still air).

⑨ Mounted to a PCB with small clip heatsink (still air)

⑨ Mounted on minimum footprint full size board with metalized back and with small clip heatsink (still air)

**Fig 4.** Typical Output Characteristics**Fig 5.** Typical Output Characteristics**Fig 6.** Typical Transfer Characteristics**Fig 7.** Normalized On-Resistance vs. Temperature**Fig 8.** Typical Capacitance vs. Drain-to-Source Voltage**Fig 9.** Typical On-Resistance vs. Drain Current and Gate Voltage

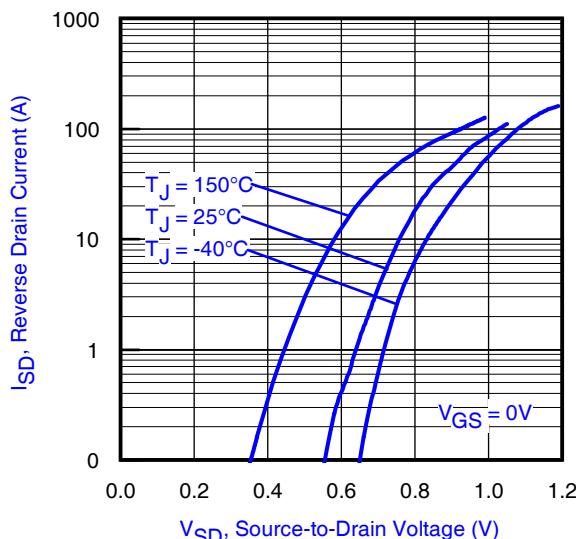


Fig 10. Typical Source-Drain Diode Forward Voltage

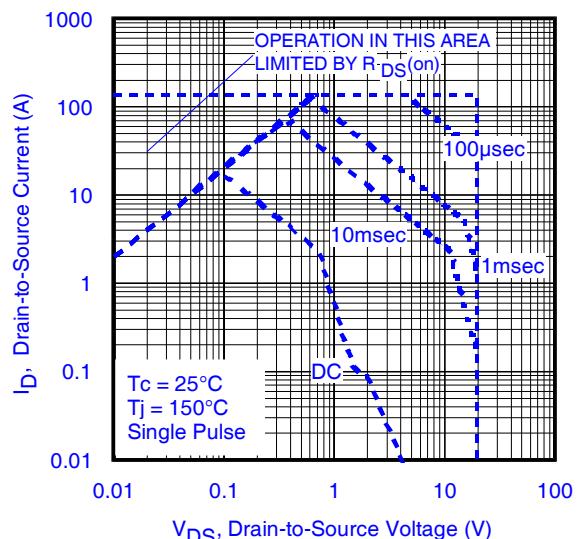


Fig 11. Maximum Safe Operating Area

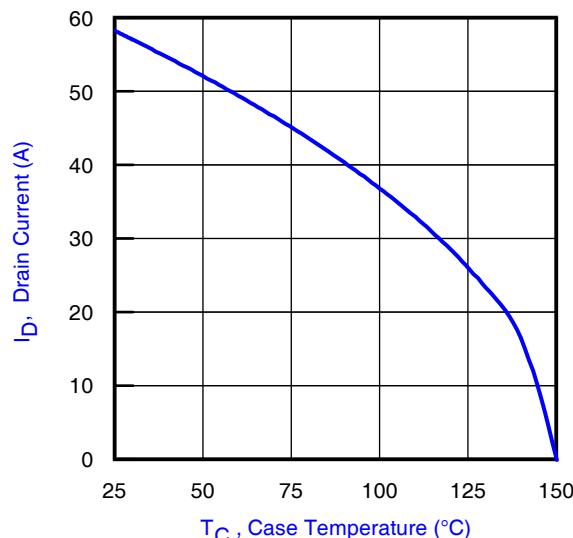


Fig 12. Maximum Drain Current vs. Case Temperature

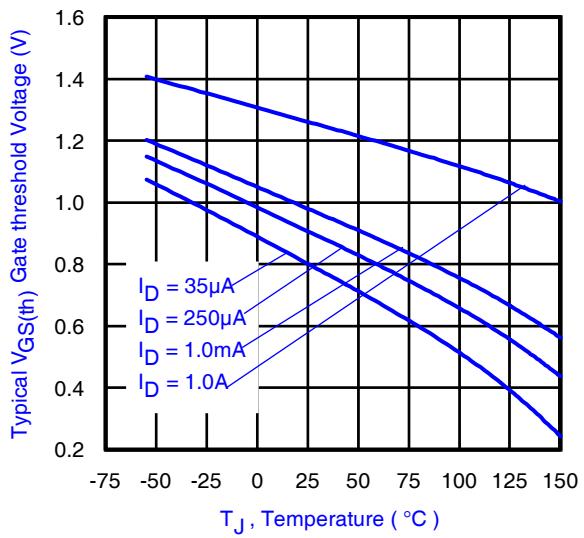


Fig 13. Typical Threshold Voltage vs. Junction Temperature

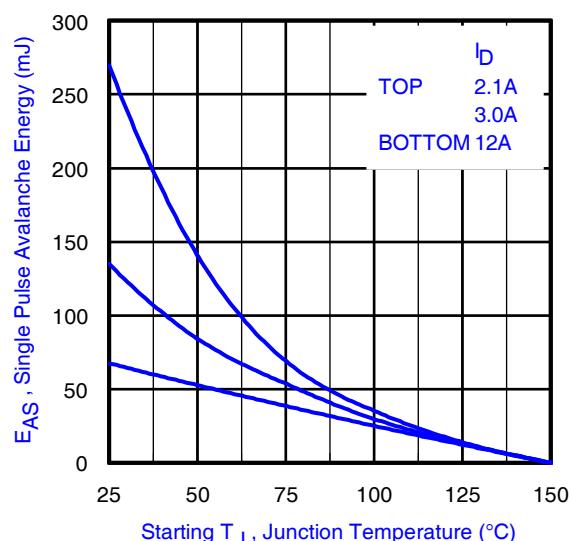


Fig 14. Maximum Avalanche Energy vs. Drain Current

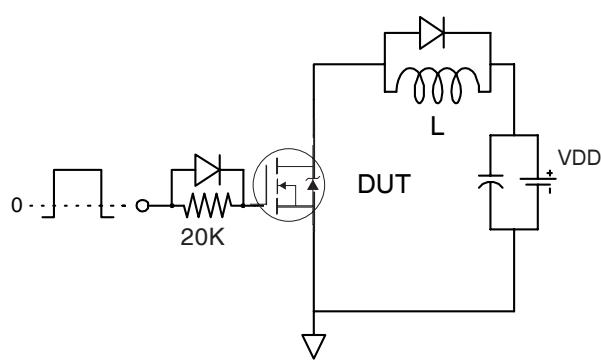


Fig 15a. Gate Charge Test Circuit

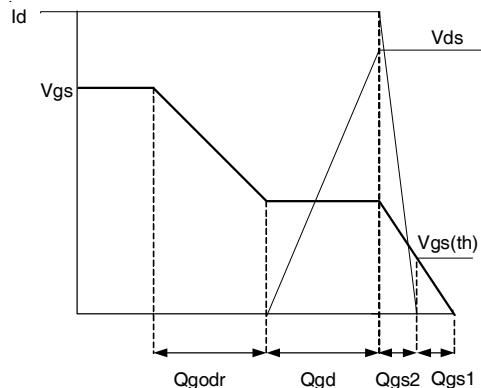


Fig 15b. Gate Charge Waveform

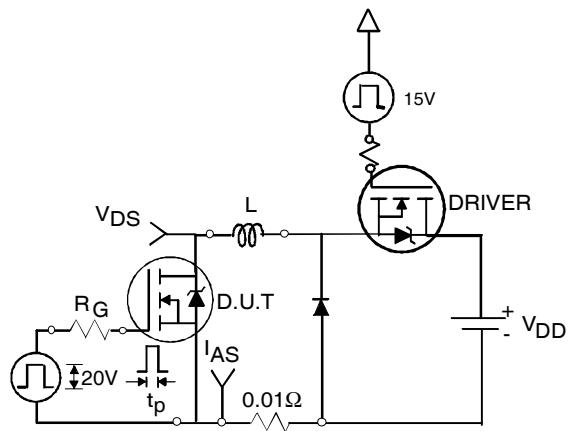


Fig 16a. Unclamped Inductive Test Circuit

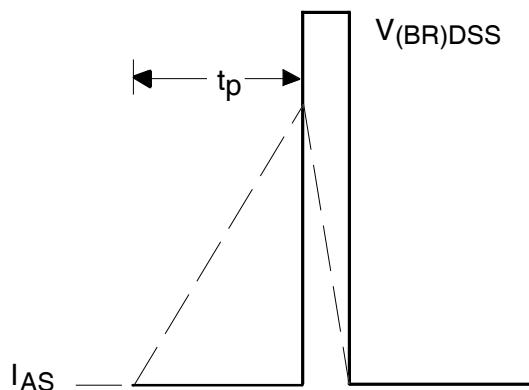


Fig 16b. Unclamped Inductive Waveforms

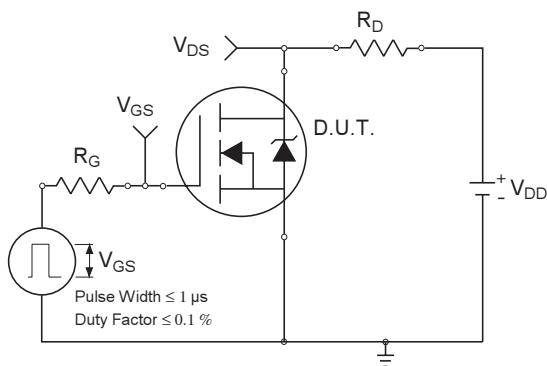


Fig 17a. Switching Time Test Circuit

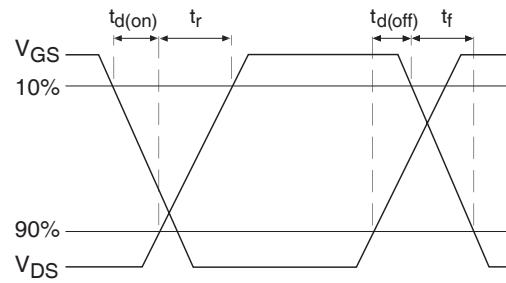


Fig 17b. Switching Time Waveforms

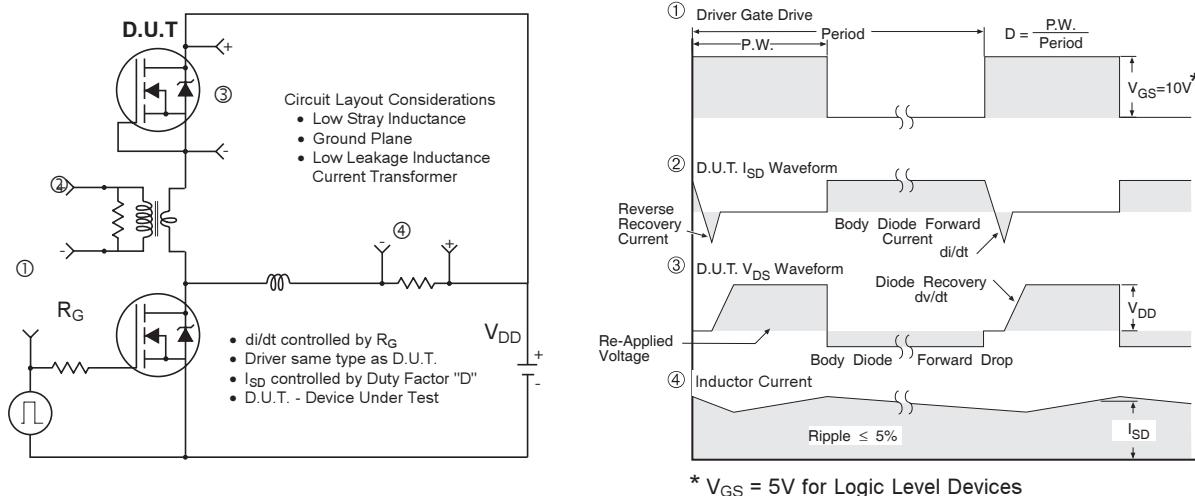
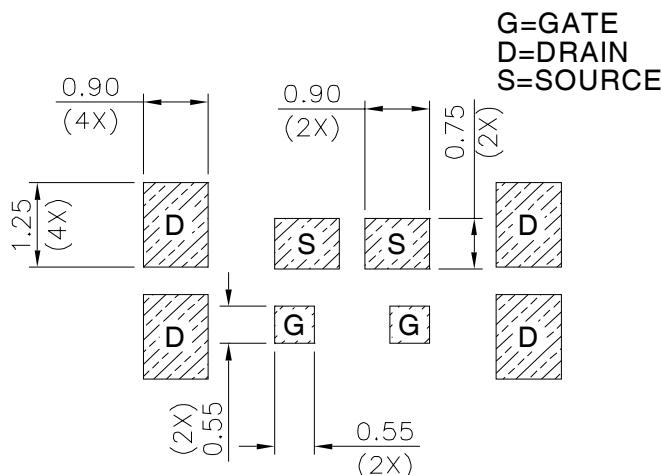
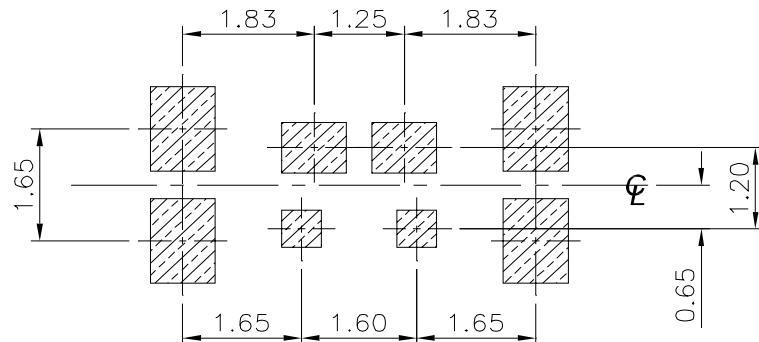


Fig 18. Diode Reverse Recovery Test Circuit for N-Channel HEXFET® Power MOSFETs

DirectFET® Board Footprint, SA Outline (Small Size Can, A-Designation).

Please see DirectFET application note AN-1035 for all details regarding the assembly of DirectFET.

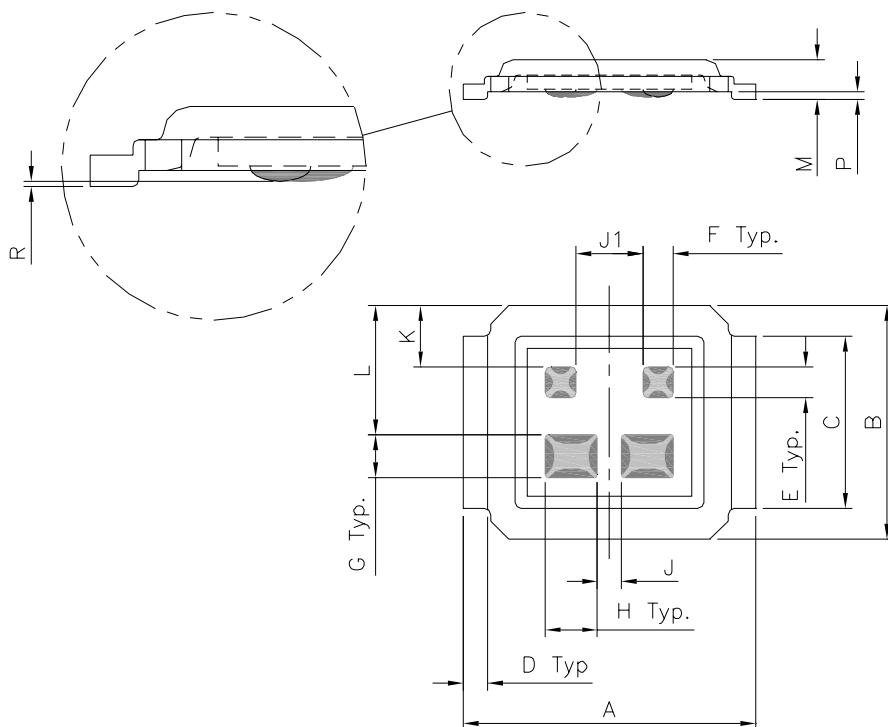
This includes all recommendations for stencil and substrate designs.



Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

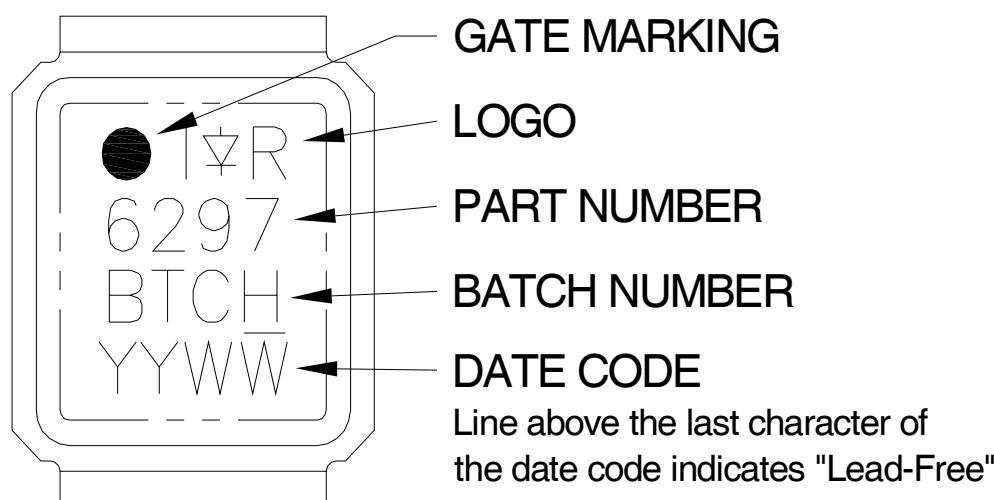
DirectFET® Outline Dimension, SA Outline (Small Size Can, A-Designation).

Please see DirectFET application note AN-1035 for all details regarding the assembly of DirectFET. This includes all recommendations for stencil and substrate designs.



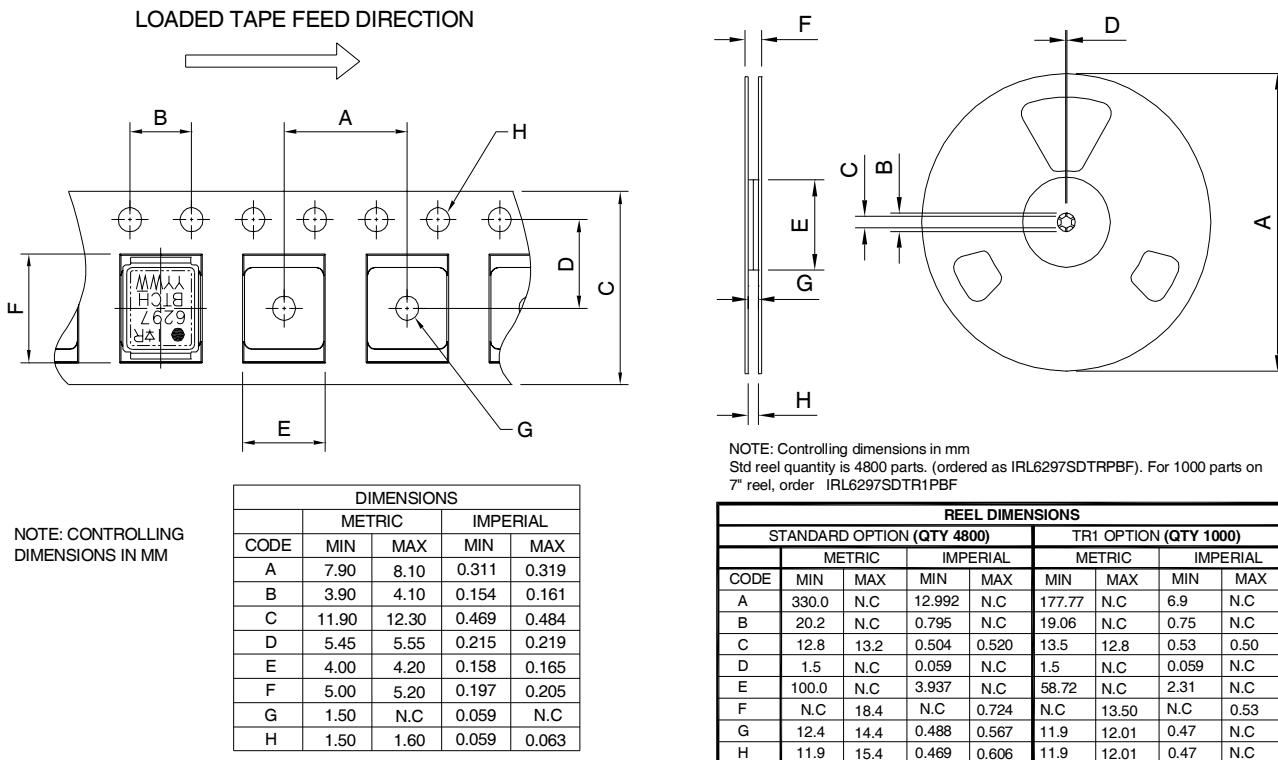
CODE	DIMENSIONS			
	METRIC	IMPERIAL	MIN	MAX
A	4.75	4.85	0.187	0.191
B	3.70	3.95	0.146	0.156
C	2.75	2.85	0.108	0.112
D	0.35	0.45	0.014	0.018
E	0.48	0.52	0.019	0.020
F	0.48	0.52	0.019	0.020
G	0.68	0.72	0.027	0.028
H	0.83	0.87	0.033	0.034
J	0.38	0.42	0.015	0.016
J1	1.08	1.12	0.043	0.044
K	0.95	1.05	0.037	0.041
L	2.05	2.15	0.081	0.085
M	0.59	0.70	0.023	0.028
P	0.08	0.17	0.003	0.007
R	0.02	0.08	0.0008	0.0031

DirectFET® Part Marking



Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

DirectFET® Tape & Reel Dimension (Showing component orientation).



Qualification Information[†]

Qualification level	Consumer ^{††}		
	(per JEDEC JESD47F ^{†††} guidelines)		
Moisture Sensitivity Level	DirectFET Small Can	MSL1 (per JEDEC J-STD-020D ^{†††})	
RoHS Compliant	Yes		

[†] Qualification standards can be found at International Rectifier's web site

<http://www.irf.com/product-info/reliability>

^{††} Higher qualification ratings may be available should the user have such requirements.

Please contact your International Rectifier sales representative for further information:

<http://www.irf.com/whoto-call/salesrep/>

^{†††} Applicable version of JEDEC standard at the time of product release.

International
IR Rectifier

IR WORLD HEADQUARTERS: 101 N. Sepulveda Blvd., El Segundo, California 90245, USA
To contact International Rectifier, please visit <http://www.irf.com/whoto-call/>